

RoHS Compliant Product
A suffix of "C" specifies halogen & lead-free

FEATURES

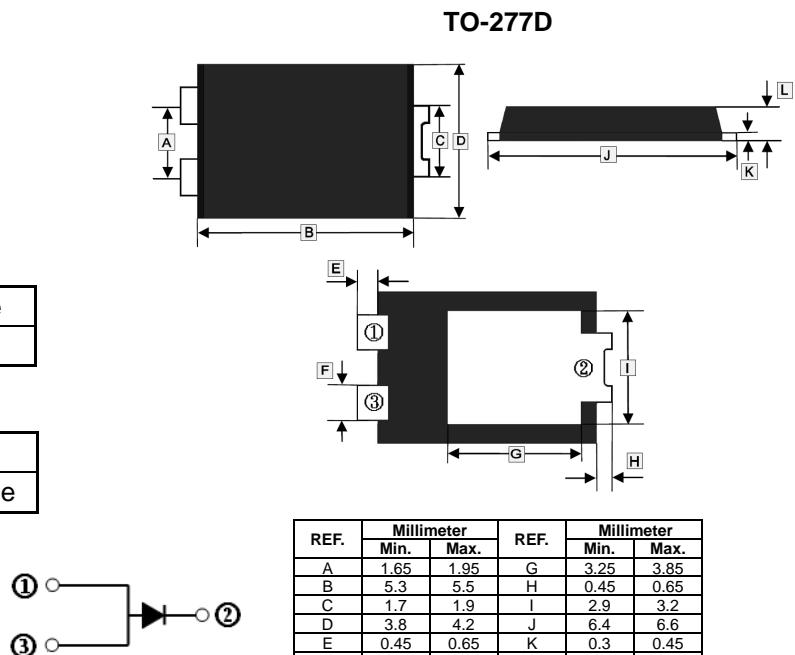
- Planar MOS Schottky technology
- High Thermal Reliability
- High Forward Surge Capability
- Ultra Low Power Loss and High Efficiency
- Excellent High Temperature Stability
- Plastic Material-UL Flammability 94V-0

PACKAGE INFORMATION

Package	MPQ	Leader Size
TO-277D	5K	13 inch

PACKAGE INFORMATION

Part Number	Type
SMPD1045-C	Lead (Pb)-free and Halogen-free



MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

(T_A=25°C, unless otherwise specified. Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, de-rate current by 20%).

Parameter	Symbol	Rating	Unit
Maximum Peak Repetitive Reverse Voltage	V _{RPM}	45	V
Maximum Working Peak Reverse Voltage	V _{RWM}	45	V
Maximum DC Blocking Voltage	V _{DC}	45	V
Maximum Average Forward Rectified Current	I _F	10	A
Non-Repetitive Peak Forward Surge Current@ 8.3ms Single Half Sine-Wave, Superimposed on Rated Load (JEDEC method)	I _{FSM}	150	A
I ² t Rating for Fusing@ t<8.3ms	I ² t	93.375	A ² S
Typical Thermal Resistance from Junction to Case ¹	R _{θJC}	7	°C / W
Operating Junction and Storage Temperature Range	T _J , T _{STG}	150, -55~150	°C

ELECTRICAL CHARACTERISTICS

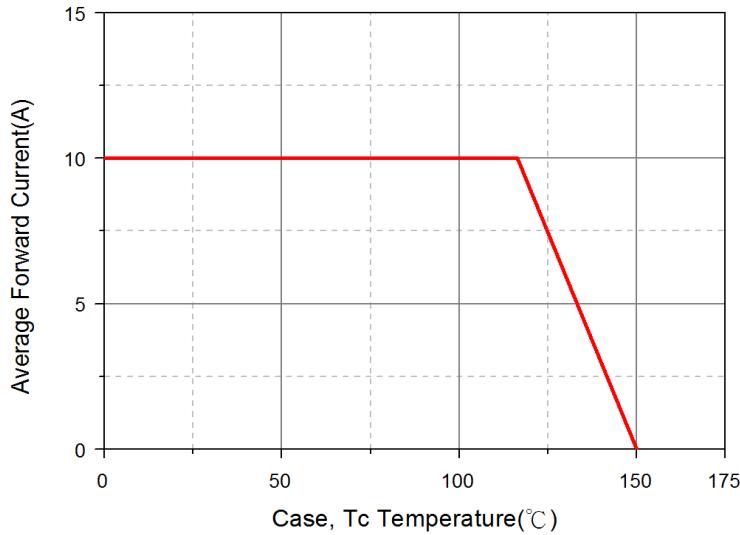
Parameter	Symbol	Typ.	Max.	Unit	Test Condition
Maximum Instantaneous Forward Voltage	V _F	0.46	0.5	V	I _F =10A, T _J =25°C
		0.45	-		I _F =10A, T _J =125°C
Maximum DC Reverse Current at Rated DC Blocking Voltage ²	I _R	-	0.5	mA	T _J =25°C
		-	15		T _J =100°C
Typical Junction Capacitance ³	C _J	420	-	pF	

Notes:

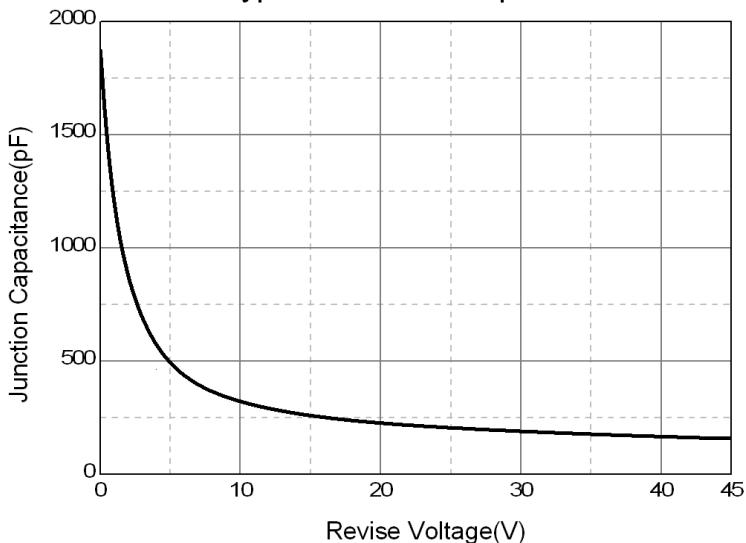
1. FR4 Board Heat sink size: 10*10*0.2mm.
2. Pulse Test : Pulse Width = 300 μs, Duty Cycle ≤ 2.0%.
3. Measured at 1MHz and applied reverse voltage of 5.0V D.C.

CHARACTERISTIC CURVES

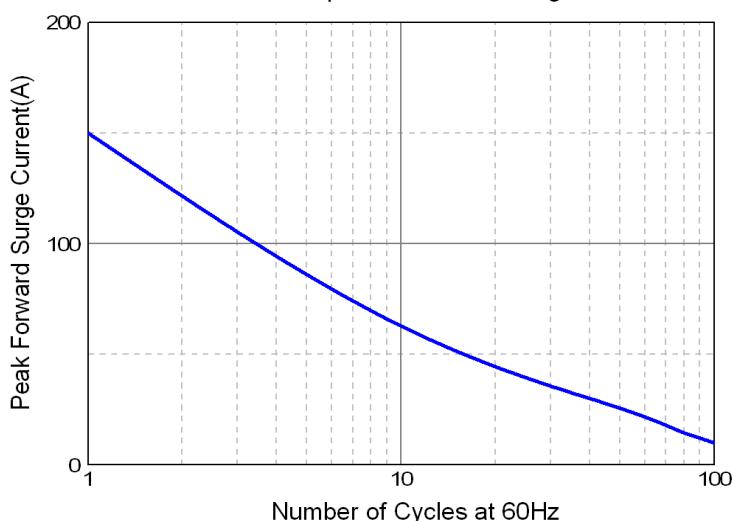
Typical Forward Current Derating Curve



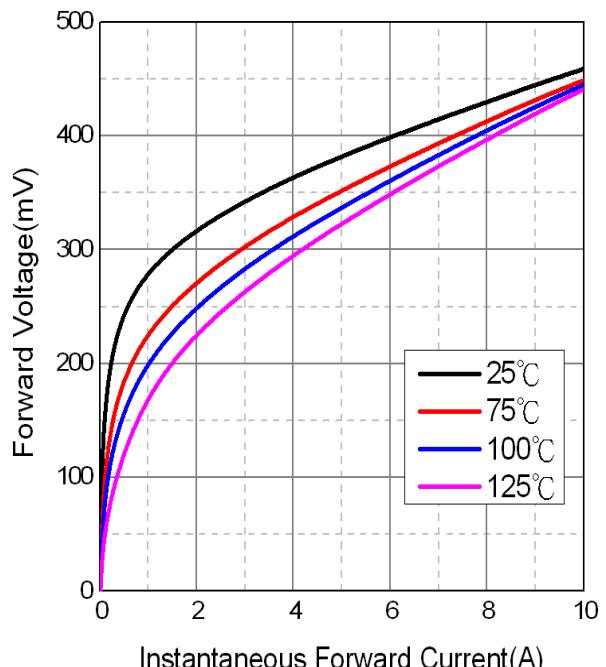
Typical Junction Capacitance



Maximum Non-Repetitive Forward Surge Current



Typical Forward Characteristic



Typical Reverse Characteristic

